

General Description

These dual N Channel enhancement mode power fieldeffect transistors are using trench DMOS technology.

This advanced technology has been especially tailoredto minimize on-state resistance, provide superior switching performance, and withstand high energypulse in the avalanche and commutation mode. Thesedevices are well suited for high efficiency fast switchingapplications.

Features

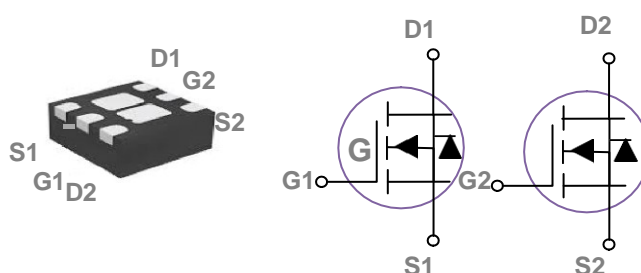
- Fast switching
- Green Device Available
- Suit for 1.8V Gate Drive Applications
- Marking : WA

Applications

- Notebook
- Load Switch
- Networking
- Hand-held Instruments

BVDSS	RDSON	ID
20V	22mΩ	6.5A

DFN2X2 Dual 2EP Pin Configuration



Absolute Maximum Ratings $T_c=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 12	V
I_D	Drain Current - Continuous ($T_c=25^{\circ}\text{C}$)	6.5	A
	Drain Current - Continuous ($T_c=100^{\circ}\text{C}$)	4.3	A
I_{DM}	Drain Current - Pulsed _r	20.8	A
P_D	Power Dissipation ($T_c=25^{\circ}\text{C}$)	1.78	W
	Power Dissipation - Derate above 25°C	0.02	W/ $^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^{\circ}\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		100	$^{\circ}\text{C}/\text{W}$

Electrical Characteristics ($T_J=25\text{ }^\circ\text{C}$, unless otherwise) noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20			V
$\frac{\mu A}{^\circ C} BV_{DSS}$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$		0.02		$V/^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=20V, V_{GS}=0V, T_J=25^\circ\text{C}$			1	μA
		$V_{DS}=16V, V_{GS}=0V, T_J=125^\circ\text{C}$			10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 10V, V_{DS}=0V$			± 100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=4.5V, I_D=3A$		22	25	$m\Omega$
		$V_{GS}=2.5V, I_D=2A$		26	30	$m\Omega$
		$V_{GS}=1.8V, I_D=1.5A$		40	45	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	0.3	0.6	1	V
$\frac{\mu A}{^\circ C} V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient			-2		$mV/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=2A$		4.4		S

Dynamic and switching Characteristics

Q_g	Total Gate Charge _{2,3}	$V_{DS}=10V, V_{GS}=4.5V, I_D=3A$		5.8	10	nC	
Q_{gs}	Gate-Source Charge _{2,3}			0.6	1.5		
Q_{gd}	Gate-Drain Charge _{2,3}			1.5	3		
$T_{d(on)}$	Turn-On Delay Time _{2,3}	$V_{DD}=10V, V_{GS}=4.5V, R_G=25$	---	2.9	6	ns	
T_r	Rise Time _{2,3}			8.4	16		
$T_{d(off)}$	Turn-Off Delay Time _{2,3}		$I_D=1A$		19.2		38
T_f	Fall Time _{2,3}				5.6		12
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, F=1\text{MHz}$		315	600	pF	
C_{oss}	Output Capacitance		---	50	80		
C_{rss}	Reverse Transfer Capacitance			40	60		

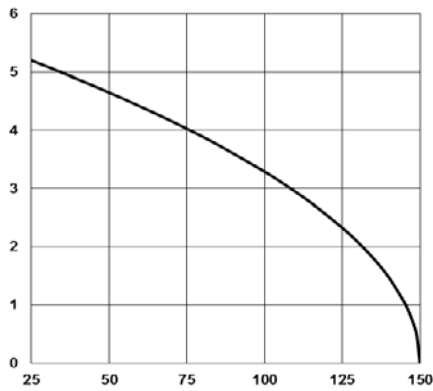
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current			3.8	A
I_{SM}	Pulsed Source Current				7.6	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$			1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

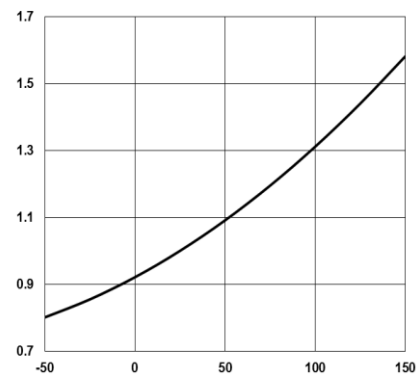
I_D , Continuous Drain Current (A)



T_C , Case Temperature ($^{\circ}C$)

Fig.1 Continuous Drain Current vs. T_C

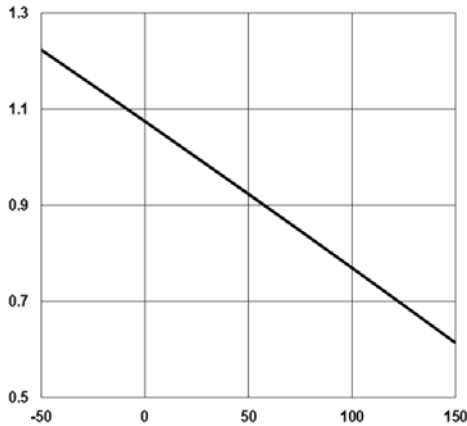
Normalized On Resistance (m)



T_J , Junction Temperature ($^{\circ}C$)

Fig.2 Normalized $R_{DS(on)}$ vs. T_J

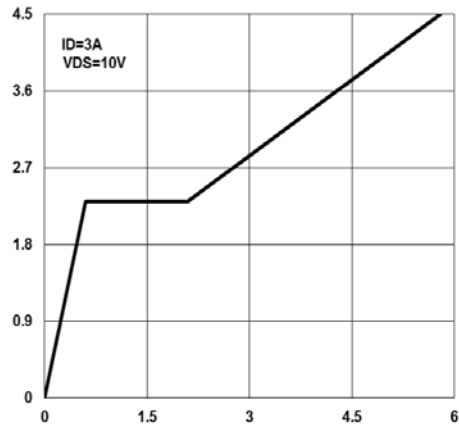
Normalized Gate Threshold Voltage (V)



T_J , Junction Temperature ($^{\circ}C$)

Fig.3 Normalized V_{th} vs. T_J

V_{GS} , Gate to Source Voltage (V)



Q_g , Gate Charge (nC)

Fig.4 Gate Charge Waveform

Normalized Thermal Response ($R_{\theta JA}$)

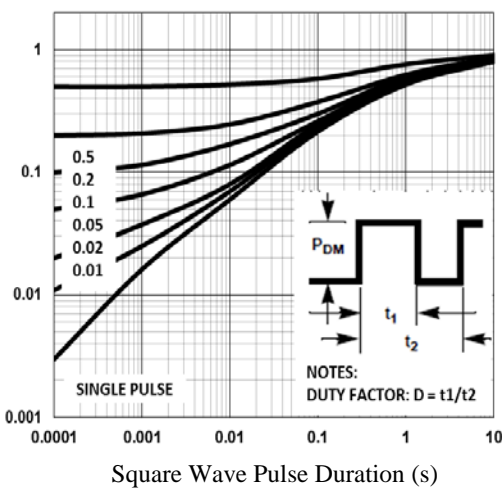


Fig.5 Normalized Transient Impedance

I_D , Continuous Drain Current (A)

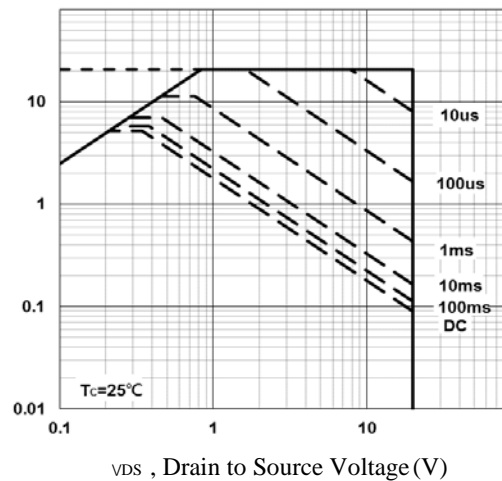


Fig.6 Maximum Safe Operation Area

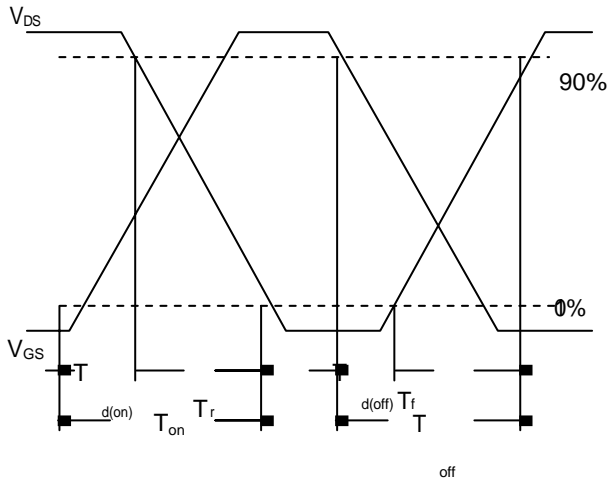


Fig.7 Switching Time Waveform

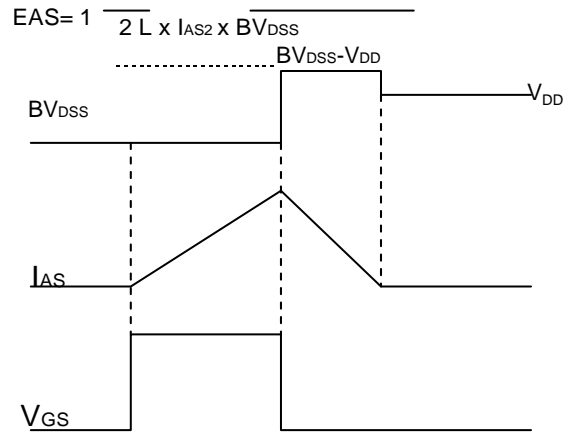
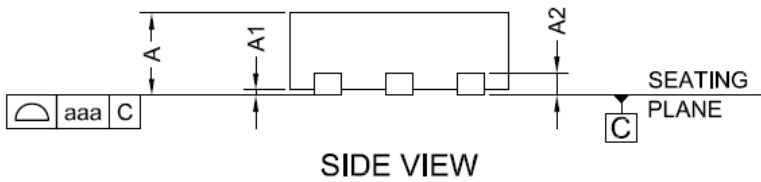
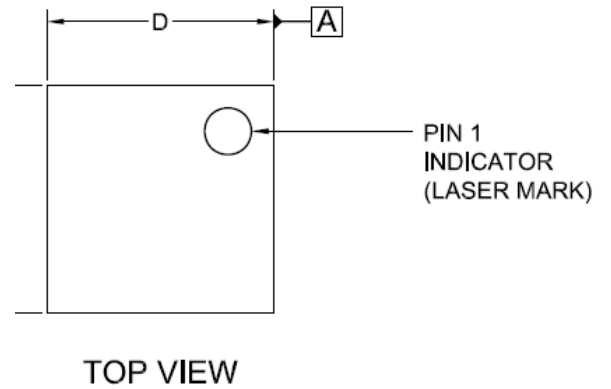
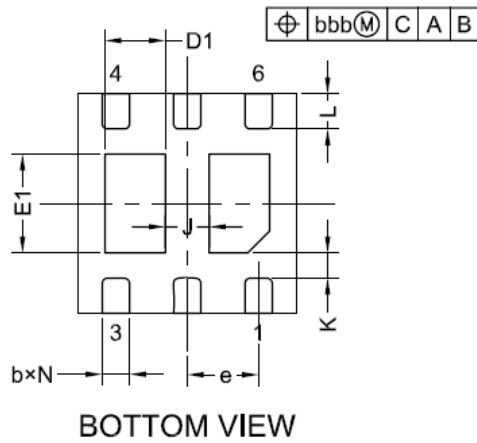


Fig.8 EAS Waveform

PPAK2X2 Dual 2EP PACKAGE INFORMATION



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.203		
b	0.20	0.25	0.30
D	1.95	2.00	2.05
D1	0.50	0.55	0.60
E	1.95	2.00	2.05
E1	0.85	0.90	0.95
e	0.65BSC		
L	0.27	0.32	0.37
J	0.40BSC		
K	0.20MIN		
N	6		
aaa	0.08		
bbb	0.10		

单击下面可查看定价，库存，交付和生命周期等信息

[>>SHIKUES\(时科\)](#)